

JUN-14-02

07:50AM FROM Armstrong, D

rman, Hattori, McLeland

202-331-4393

T-840 P.004/009 F-137

#6/14/02 Amt. A w/Ext.(1)
L. M. Mireya -
6/18/02

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of: Tomoo UJIMA et al.

Serial Number: 09/466,895

Filed: December 20, 1999

Group Art Unit: 3729

For: WIRING SUBSTRATE FOR MOUNTING
SEMICONDUCTOR ELEMENTS AND
FABRICATING METHOD THEREOF

Examiner: S. SMITH

AMENDMENT UNDER 37 CFR §1.111

Commissioner for Patents

Washington, D.C. 20231

January 14, 2002

Sir:

In response to the Office Action dated September 14, 2001, extended to January 14, 2002 by a one-month Petition for Extension of Time, please amend the above-identified application as follows:

IN THE TITLE:

Amend the title to read as follows:

~~METHOD FOR FABRICATING A WIRING SUBSTRATE~~

IN THE ABSTRACT:

~~Delete the current Abstract and replace therewith the attached substitute Abstract.~~

IN THE CLAIMS:

~~Please cancel claims 1 and 3-14 without prejudice or disclaimer.~~

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